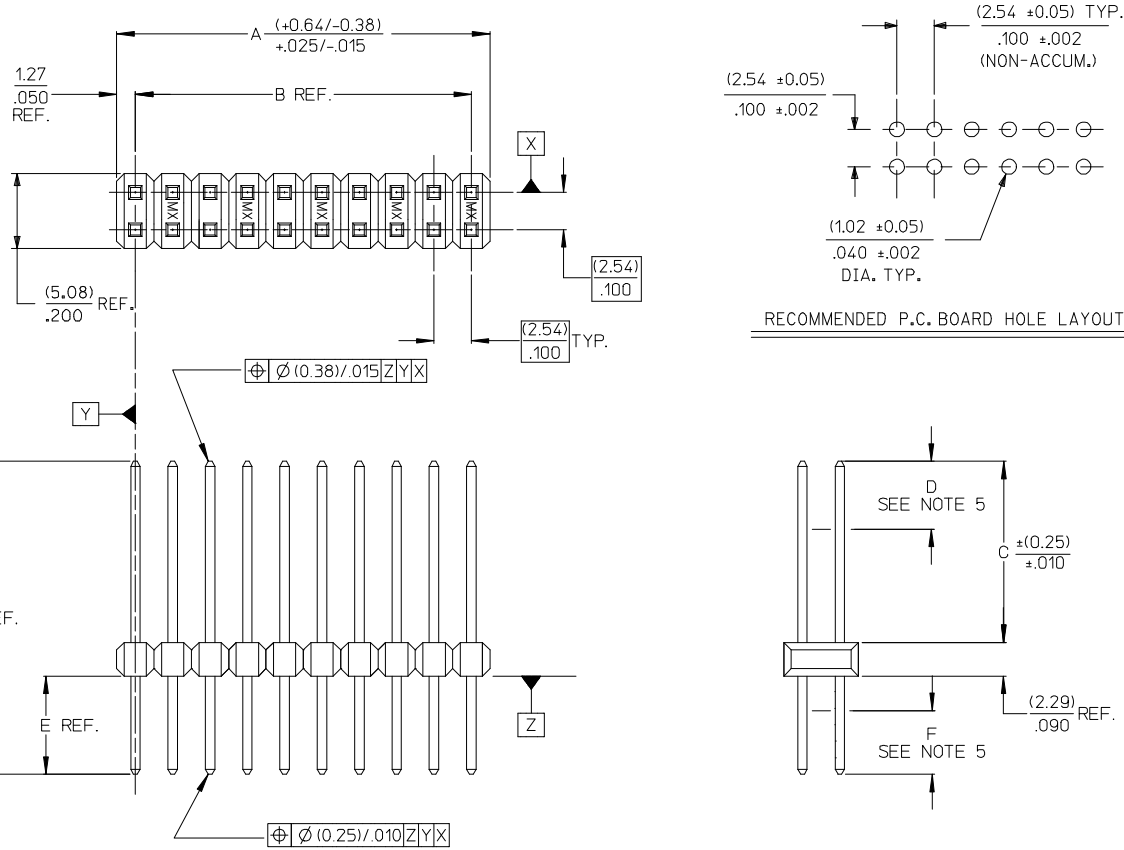


CKT. SIZE	DIM. A REF.		DIM. B REF.		
	(MM)	INCH	(MM)	INCH	
J	4	(5.08)	.200	(2.54)	.100
	6	(7.62)	.300	(5.08)	.200
	8	(10.16)	.400	(7.62)	.300
	10	(12.70)	.500	(10.16)	.400
	12	(15.24)	.600	(12.70)	.500
	14	(17.78)	.700	(15.24)	.600
I	16	(20.32)	.800	(17.78)	.700
	18	(22.86)	.900	(20.32)	.800
	20	(25.40)	1.000	(22.86)	.900
	22	(27.94)	1.100	(25.40)	1.000
	24	(30.48)	1.200	(27.94)	1.100
	26	(33.02)	1.300	(30.48)	1.200
	28	(35.56)	1.400	(33.02)	1.300
H	30	(38.10)	1.500	(35.56)	1.400
	32	(40.64)	1.600	(38.10)	1.500
	34	(43.18)	1.700	(40.64)	1.600
	36	(45.72)	1.800	(43.18)	1.700
	38	(48.26)	1.900	(45.72)	1.800
	40	(50.80)	2.000	(48.26)	1.900
G	42	(53.34)	2.100	(50.80)	2.000
	44	(55.88)	2.200	(53.34)	2.100
	46	(58.42)	2.300	(55.88)	2.200
	48	(60.96)	2.400	(58.42)	2.300
	50	(63.50)	2.500	(60.96)	2.400
	52	(66.04)	2.600	(63.50)	2.500
	54	(68.58)	2.700	(66.04)	2.600
F	56	(71.12)	2.800	(68.58)	2.700
	58	(73.66)	2.900	(71.12)	2.800
	60	(76.20)	3.000	(73.66)	2.900
	62	(78.74)	3.100	(76.20)	3.000
	64	(81.28)	3.200	(78.74)	3.100
	66	(83.82)	3.300	(81.28)	3.200
E	68	(86.36)	3.400	(83.82)	3.300
	70	(88.90)	3.500	(86.36)	3.400
	72	(91.44)	3.600	(88.90)	3.500
	74	(93.98)	3.700	(91.44)	3.600
	76	(96.52)	3.800	(93.98)	3.700
	78	(99.06)	3.900	(96.52)	3.800
D	80	(101.06)	4.000	(99.06)	3.900
	82	(104.14)	4.100	(101.06)	4.000
	84	(106.68)	4.200	(104.14)	4.100
	86	(109.22)	4.300	(106.68)	4.200
	88	(111.76)	4.400	(109.22)	4.300
	90	(114.30)	4.500	(111.76)	4.400
	92	(116.84)	4.600	(114.30)	4.500
C	94	(119.38)	4.700	(116.84)	4.600
	96	(121.92)	4.800	(119.38)	4.700
	98	(124.46)	4.900	(121.92)	4.800
	100	(127.00)	5.000	(124.46)	4.900

**NOTES:**

- MATERIAL:  
PIN: COPPER ALLOY  
WAFER: GLASS FILLED LCP (LIQUID CRYSTAL POLYMER, UL 94V-0, COLOR: BLACK).
- FINISH:  
TIN = (0.00380)/.000150 MINIMUM TIN PLATE OVER (0.00127)/.000050 MINIMUM NICKEL PLATE.  
15 GOLD = (0.00038)/.000015 MINIMUM GOLD PLATE IN SELECT AREA, (0.00190)/.000075 MINIMUM TIN PLATE IN SELECT AREA, OVER (0.00127)/.000050 MINIMUM NICKEL PLATE OVERALL.  
30 GOLD = (0.00076)/.000030 MINIMUM GOLD PLATE IN SELECT AREA, (0.00190)/.000075 MINIMUM TIN PLATE IN SELECT AREA, OVER (0.00127)/.000050 MINIMUM NICKEL PLATE OVERALL.  
GT15 = (0.00038)/.000015 MINIMUM GOLD PLATE IN SELECT AREA, (0.00254)/.000100 MINIMUM TIN PLATE IN SELECT AREA, OVER (0.00127)/.000050 MINIMUM NICKEL PLATE OVERALL.
- PRODUCT SPECIFICATION NONE
- PACKAGING INFORMATION: (UNLESS OTHERWISE NOTED IN TABLES) BULK PACK PER PK-70873-0353.
- MEASURE POINT FOR PLATING THICKNESS.
- FOR ASSEMBLIES WITH VOIDED PINS, REFER TO DRAWING NO. SDA-70280-5001-9999.
- PIN PUSHOUT FORCE 3 POUNDS MINIMUM IN EITHER DIRECTION.
- FOR ILLUSTRATION PURPOSES, 20 (DUAL 10) CIRCUIT SIZE IS SHOWN.
- PINS MEET SOLDERABILITY SPEC SMES-152. ABSENCE OF PLATING PERMISSIBLE AT BANDOLIER PIN FAYING SURFACE. (APPROXIMATELY (0.64)/.025 INCH LONG BY (0.15)/.006 INCH WIDE AT 2 LOCATIONS)
- PARTS CONFORM TO CLASS B OF COSMETIC SPECIFICATION PS-45499-002

\* THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH LEAD PLATING.



ADD P/N 70280-1254 EC NO: UCP2008-2306 DRWN: J.BELL 2008/03/31 CHKD: LSCMIDT 2008/04/07 APPR: FSM/TH 2008/04/24	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE MM/IN		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION
			mm	INCH	DRAWN BY SMR	DATE 04/19/1993	TITLE SALES ASSY-HIGH TEMP. DUAL ROW WAFER W/BREAK-OFF OPT. .025 SQ PINS
G6	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	MATERIAL NO. SEE TABLE		DOCUMENT NO. SDA-70280-0001-4000		SHEET NO. 1 OF 9
			APPROVED BY SMR		DATE 04/19/1993	MATERIAL NO. SDA-70280-0001-4000	
G6		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

9	G6
8	G5
7	G3
6	G3
5	G3
4	G3
3	G3
2	G3
1	G6
SHT. REV.	

Main table with columns 13-1 and rows J-H. Columns include ENGINEERING NUMBER, RELEASE FOR MANUFACTURE, E REF., J REF., C REF., CONNECTOR END PLATING, P.C. BOARD END PLATING, and FOR PACKAGING INFORMATION.

lb\_frame\_C\_P\_M\_E\_T Rev. E 2006/04/15

12 11 10 9 8 7 6 5 4 3 2 1

UPDATE DIMENSIONS EC NO: UCP2007-1440 DRAWN: PPR/DER 2006/12/18 CHKD: AQR/RR 2006/12/18 APPR: ESM/TH 2007/01/10

QUALITY SYMBOLS: 0 (triangle), 0 (square), 0 (circle). DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS.

GENERAL TOLERANCES (UNLESS SPECIFIED): mm, INCH. DIMENSION STYLE: MM/IN. DRAWN BY: SMR, DATE: 1993/04/19. CHECKED BY: DATE: APPROVED BY: SMR, DATE: 1993/04/19.

SCALE: --- DESIGN UNITS: INCH. THIRD ANGLE PROJECTION. SALES ASSY-HIGH TEMP. DUAL ROW WAFER W/BREAK-OFF OPTION, .025 SQ PINS. MOLEX INCORPORATED. SHEET NO. 2 OF 8.